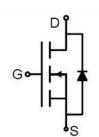
100V,8A
R_{DS (ON)} < 25m Ω @V_{GS}=10V TYP: 18m Ω
R_{DS (ON)} < 32m Ω @V_{GS}=4.5V TYP: 25m Ω

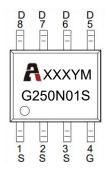
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent R_{DS (ON)} and Low Gate Charge

Applications

- PWM applications
- Load Switch
- Power management



Schematic Diagram



Marking and pin Assignment

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
G250N01S	APG250N01S	SOP-8	-	-	4000

ABSOLUTE MAXIMUM RATINGS (TJ=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Tc=25 $^\circ\!\!{\rm C}$) $^{(1)}$	Ι _D	8	A
Continuous Drain Current (Tc=100 $^\circ\!\mathrm{C}$)	Ι _D	5	A
Pulsed Drain Current ⁽¹⁾	I _{DM}	32	A
Drain Power Dissipation	PD	50	W
Single Pulsed Avalanche Energy ⁽²⁾	E _{AS}	11	mJ
Thermal Resistance from Junction to Ambient	R _{0JA}	42	°C/W
Thermal Resistance from Junction to Case	Rejc	2.5	°C/W
Junction Temperature	TJ	-55~ +150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

Notes:

- 1) Repetitive Rating: pulse width limited by maximum junction temperature
- 2) EAS condition : $T_J=25^{\circ}C$, $V_{DD}=20V$, $V_G=10V$, L=0.5mH, $R_g=25\Omega$, $I_{AS}=6.6A$

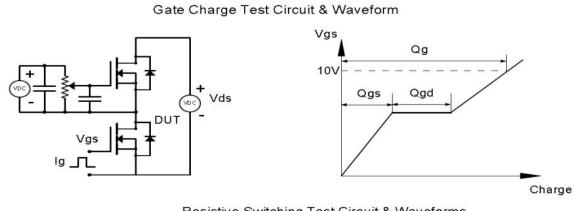




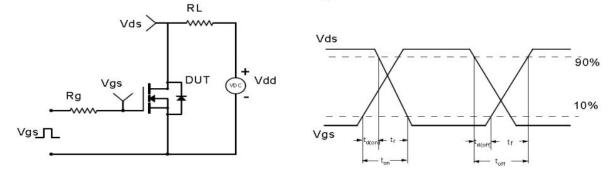
MOSFET ELECTRICAL CHARACTERISTICS(TJ=25℃ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250µA	100	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =100V, V _{GS} = 0V	-	-	1	μA
Gate-body leakage current	I _{GSS}	V_{GS} =±20V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250µA	1.2	1.8	2.5	V
	_	V _{GS} =10V, I _D =6A	-	18	25	mΩ
Drain-source on-resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =5A	-	25	32	
Gate Resistance	Rg	V _{GS} =0V, V _{DS} =0V, f = 1MHz	-	1.6	-	Ω
Dynamic characteristics	•	·	•	•		
Input Capacitance	Ciss		-	822	-	pF
Output Capacitance	Coss	V _{DS} =50V, VGS=0V, f=1MHz	-	310	-	
Reverse Transfer Capacitance	C _{rss}		-	23.5	-	
Switching characteristics	•		•	•		
Turn-on delay time	t _{d(on)}	-		15	-	
Turn-on rise time	tr	V _{DD} =50V, I _D =6A,	-	3.2	-	ns
Turn-off delay time	t _{d(off)}	V _{GS} =10V, R _G =3Ω	-	30	-	
Turn-off fall time	t _f	-	-	7.6	-	
Total Gate Charge	Qg		-	22.7	-	nC
Gate-Source Charge	Qgs	V_{DS} =50V, I _D =6A,	-	6.2	-	
Gate-Drain Charge	Qgd	V _{GS} =10V	-	5.3	-	
Source-Drain Diode characteristics	•		·	•		
Diode Forward voltage	V _{SD}	T_J=25℃, V _{GS} =0V, I _S =6A	-	0.8	1.2	V
Diode Forward current	ls	T _C =25℃	-	-	8	А
Body Diode Reverse Recovery Time	trr		-	45	-	ns
Body Diode Reverse Recovery Charge	Qrr	− T _J =25°C, I _F =6A,di/dt=100A/us	-	59	-	nC

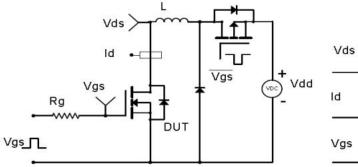
Test Circuit & Waveform

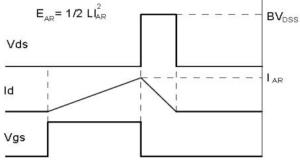


Resistive Switching Test Circuit & Waveforms

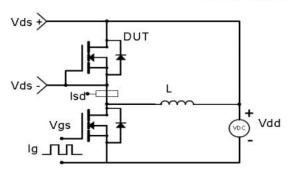


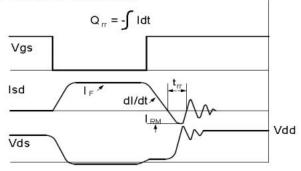
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





Typical Characteristics

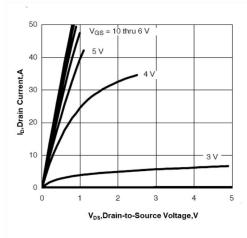


Figure 1. Output Characteristics

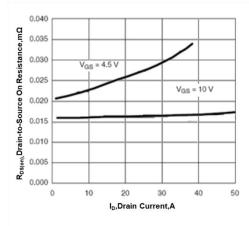


Figure 3. Drain-to-Source On Resistance vs Drain Current

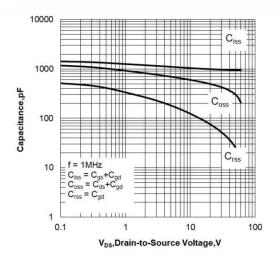


Figure 5. Capacitance Characteristics

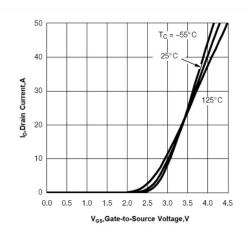


Figure 2. Transfer Characteristics

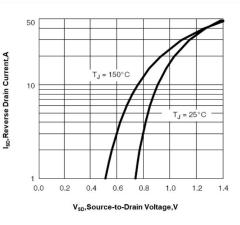


Figure 4. Body Diode Forward Voltage vs Source Current and Temperature

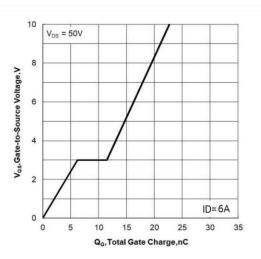


Figure 6. Gate Charge Characteristics

AII POWER DATA SHEET

Typical Characteristics

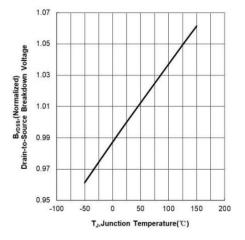


Figure 7. Normalized Breakdown Voltage vs Junction Temperature

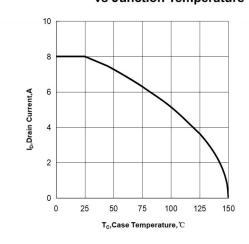
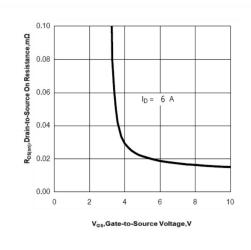
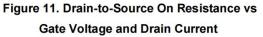


Figure 9. Maximum Continuous Drain Current vs Case Temperature





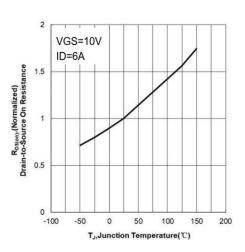


Figure 8. Normalized On Resistance vs

Junction Temperature

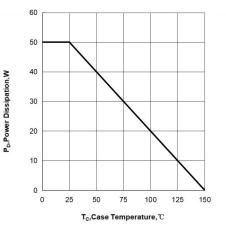


Figure 10. Maximum Power Dissipation vs Case Temperature

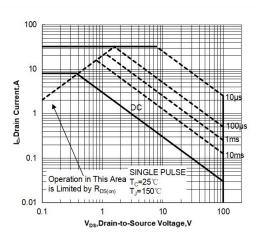
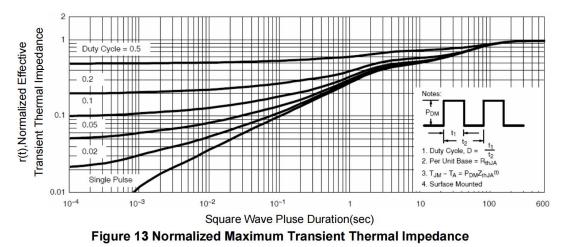


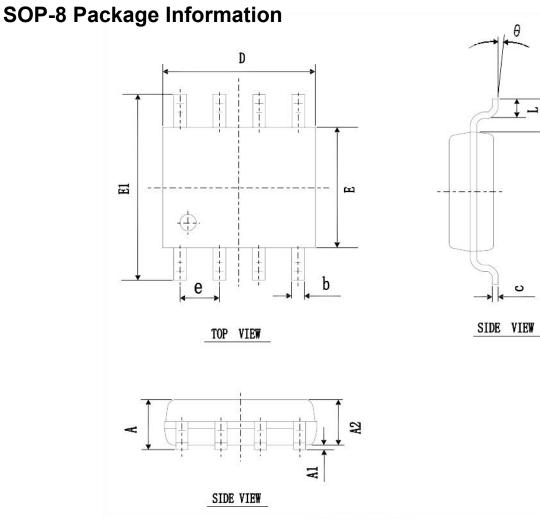
Figure 12. Maximum Safe Operating Area

Typical Characteristics



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COMMON DIMENSIONS (UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	1.35	1.60	1.80
A1	0.05	0. 15	0.25
A2	1.30	1. 45	1.60
b	0.30	0. 40	0. 50
C	0.153	0.203	0. 253
D	4.80	4. 90	5.00
E	3. 80	3.90	4.00
E1	5.80	6.00	6.20
L	0. 40	0.70	1.25
θ	0°		7°
L1	1.04 REF		
e		1.27 BSC	



Revision History

Revision	Release	Remark
V1.1	2025/04/07	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product,but similar performance is not guaranteed under other working conditions,and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which

requires high reliability.Customers using or selling these products for use in medical,life-saving,or lifesustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.